



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of : Confirmation No. 6849  
Takeshi HASHIMOTO et al. : Docket No. 2001\_1790  
Serial No. 10/029,991 : Group Art Unit 1712  
Filed December 31, 2001 : Examiner M. Zimmer

THERMOSETTING LOW-DIELECTRIC RESIN  
COMPOSITION AND USE THEREOF

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**RESPONSE**

THE COMMISSIONER IS AUTHORIZED  
TO CHARGE ANY DEFICIENCY IN THE  
FEES FOR THIS PAPER TO DEPOSIT  
ACCOUNT NO. 23-0975

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

In response to the Official Action dated April 10, 2003, the period for response having been extended for one month by the attached Petition, please amend the present application as follows:

RECEIVED  
AUG 13 2003  
TC 1700